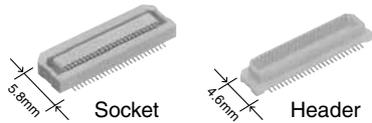


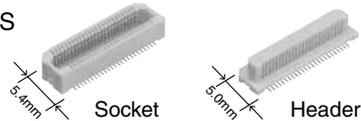
For board-to-board	P5K, P5KS Series
Narrow pitch connectors (0.5mm pitch)	



• P5K



• P5KS



Note: The external appearance and PC board pattern differs between the P5K and P5KS series.

RoHS compliant

FEATURES

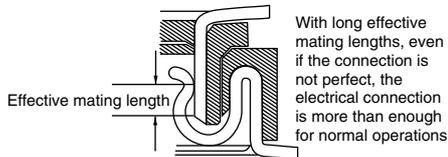
1. The product lineup consists of 3.0 mm, 3.5 mm, 4.0 mm, 4.5 mm, 5.0 mm, 5.5 mm, 6.0 mm, 6.5 mm, 7.0 mm, 8.0 mm, and 9.0 mm mated heights.

Type	Mated height	Notes
P5K	3 mm, 3.5 mm	The external appearance and PC board pattern differs for the P5K and P5KS series.
P5KS	4 mm, 4.5 mm, 5 mm, 5.5 mm, 6 mm, 6.5 mm, 7 mm, 8 mm, 9 mm	

2. Strong resistance to adverse environments! Utilizes

“**TOUGH CONTACT**” construction for high contact reliability.

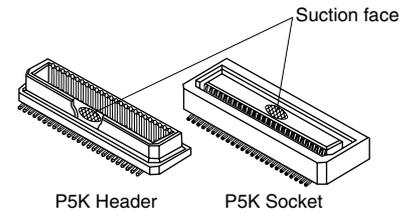
3. Even with a low profile, the effective mating length has been extended to ensure that there for insertion.



Type	Effective mating length
P5K	0.65 mm
P5KS	1.0 mm

4. Automatic mounting

Suction area for automatic mounting machines is employed.



APPLICATIONS

Digital devices, such as laptop, digital still cameras and digital video cameras

ORDERING INFORMATION

1. P5K (3.0 mm and 3.5 mm)

5: Narrow Pitch Connector P5K Socket

6: Narrow Pitch Connector P5K Header

Number of pins (2 digits)

Mated height

<Socket>

1: For mated height 3.0 mm and 3.5 mm

<Header>

2: For mated height 3.5 mm

3: For mated height 3.0 mm

Functions

4: Without positioning bosses

Surface treatment (Contact portion / Terminal portion)

7: Ni plating on base, Au plating on surface /

Ni plating on base, Au plating on surface (Ni barrier product)

Contact portion

<Socket> Y: V notch type product

<Header> Y: V notch type product

Packing

G: 1,500 pieces embossed tape and plastic reel × 2

AXK

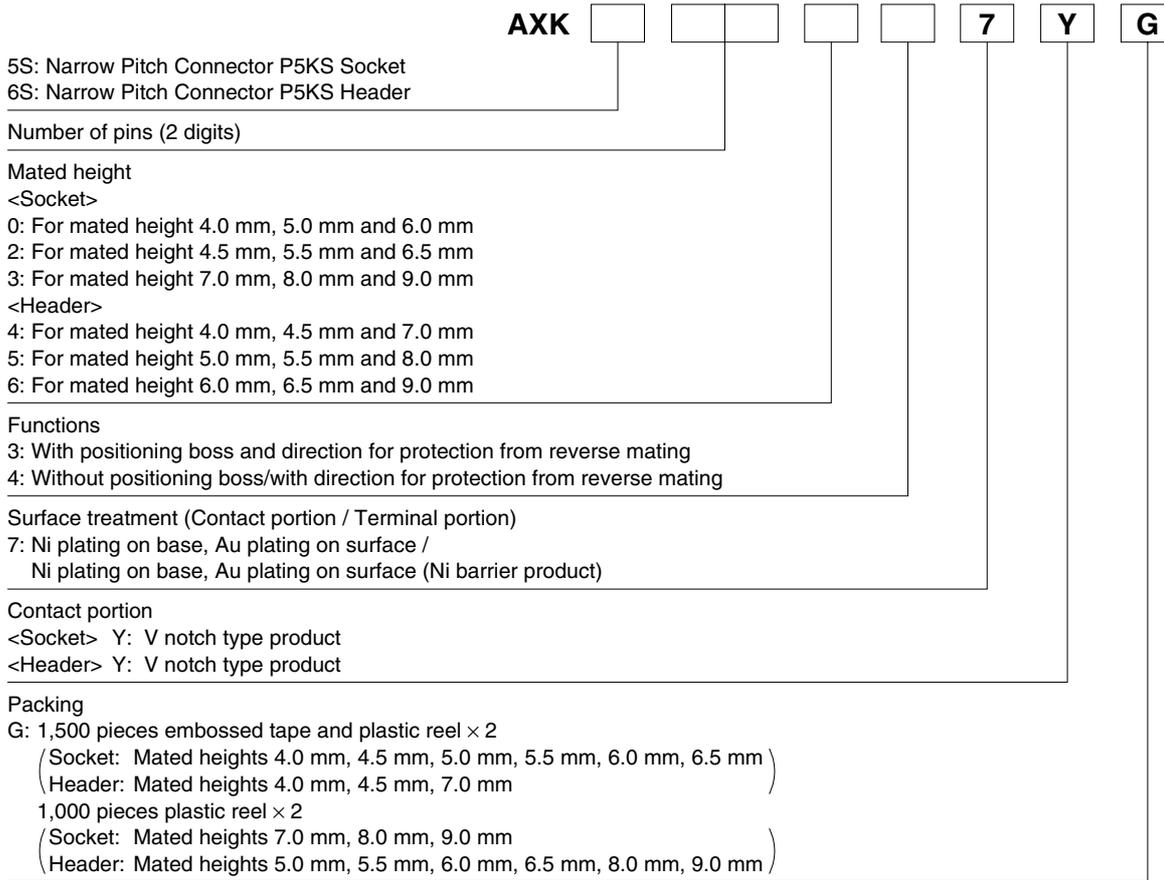
7

Y

G

Narrow pitch connectors P5K, P5KS (0.5mm pitch)

2. P5KS (4.0 mm, 4.5 mm, 5.0 mm, 5.5 mm, 6.0 mm, 6.5 mm, 7.0 mm, 8.0 mm and 9.0 mm)



PRODUCT TYPES

1. P5K

Product name	Mated height	No. of pins	Part No.		Packing		
			Socket	Header	Inner carton (1 reel)	Outer carton	
			TOUGH CONTACT	TOUGH CONTACT			
P5K	3.0 mm	20	AXK520147YG	AXK620347YG	1,500 pieces	3,000 pieces	
		22	AXK522147YG	AXK622347YG			
		30	AXK530147YG	AXK630347YG			
		40	AXK540147YG	AXK640347YG			
		50	AXK550147YG	AXK650347YG			
		60	AXK560147YG	AXK660347YG			
		70	AXK570147YG	AXK670347YG			
		80	AXK580147YG	AXK680347YG			
		100	AXK500147YG	AXK600347YG			
		120	AXK5A2147YG	AXK6A2347YG			
		3.5 mm	20	AXK520147YG			AXK620247YG
			22	AXK522147YG			AXK622247YG
	30		AXK530147YG	AXK630247YG			
	34		AXK534147YG	AXK634247YG			
	40		AXK540147YG	AXK640247YG			
	50		AXK550147YG	AXK650247YG			
	60		AXK560147YG	AXK660247YG			
	70		AXK570147YG	AXK670247YG			
	80		AXK580147YG	AXK680247YG			
	100		AXK500147YG	AXK600247YG			
	120		AXK5A2147YG	AXK6A2247YG			

Notes: 1. Regarding ordering units: During production: Please make orders in 1 reel units.
 Samples for mounting confirmation: Available in units of 50 pieces. Please contact our sales office.
 Samples: Small lot orders are possible.
 2. The standard type comes without positioning bosses.

2. P5KS

Product name	Mated height	No. of pins	Part No.		Packing		
			Socket	Header	Inner carton (1 reel)	Outer carton	
			<i>TOUGH CONTACT</i>	<i>TOUGH CONTACT</i>			
P5KS	4.0 mm	20	AXK5S20047YG	AXK6S20447YG	1,500 pieces	3,000 pieces	
		24	AXK5S24047YG	AXK6S24447YG			
		30	AXK5S30047YG	AXK6S30447YG			
		34	AXK5S34047YG	AXK6S34447YG			
		40	AXK5S40047YG	AXK6S40447YG			
		50	AXK5S50047YG	AXK6S50447YG			
		60	AXK5S60047YG	AXK6S60447YG			
		70	AXK5S70047YG	AXK6S70447YG			
		80	AXK5S80047YG	AXK6S80447YG			
	100	AXK5S00047YG	AXK6S00447YG				
	4.5 mm	20	AXK5S20247YG	AXK6S20447YG			
		24	AXK5S24247YG	AXK6S24447YG			
		30	AXK5S30247YG	AXK6S30447YG			
		34	AXK5S34247YG	AXK6S34447YG			
		36	AXK5S36247YG	AXK6S36447YG			
		40	AXK5S40247YG	AXK6S40447YG			
		50	AXK5S50247YG	AXK6S50447YG			
		60	AXK5S60247YG	AXK6S60447YG			
70		AXK5S70247YG	AXK6S70447YG				
80	AXK5S80247YG	AXK6S80447YG					
100	AXK5S00247YG	AXK6S00447YG					
P5KS	5.0 mm	20	AXK5S20047YG	AXK6S20547YG	Socket: 1,500 pieces Header: 1,000 pieces	Socket: 3,000 pieces Header: 2,000 pieces	
		24	AXK5S24047YG	AXK6S24547YG			
		30	AXK5S30047YG	AXK6S30547YG			
		34	AXK5S34047YG	AXK6S34547YG			
		40	AXK5S40047YG	AXK6S40547YG			
		50	AXK5S50047YG	AXK6S50547YG			
		60	AXK5S60047YG	AXK6S60547YG			
		70	AXK5S70047YG	AXK6S70547YG			
		80	AXK5S80047YG	AXK6S80547YG			
		100	AXK5S00047YG	AXK6S00547YG			
	5.5 mm	20	AXK5S20247YG	AXK6S20547YG			
		24	AXK5S24247YG	AXK6S24547YG			
		30	AXK5S30247YG	AXK6S30547YG			
		34	AXK5S34247YG	AXK6S34547YG			
		40	AXK5S40247YG	AXK6S40547YG			
		50	AXK5S50247YG	AXK6S50547YG			
		60	AXK5S60247YG	AXK6S60547YG			
		70	AXK5S70247YG	AXK6S70547YG			
		80	AXK5S80247YG	AXK6S80547YG			
		100	AXK5S00247YG	AXK6S00547YG			
	6.0 mm	20	AXK5S20047YG	AXK6S20647YG			
		30	AXK5S30047YG	AXK6S30647YG			
		40	AXK5S40047YG	AXK6S40647YG			
		50	AXK5S50047YG	AXK6S50647YG			
		60	AXK5S60047YG	AXK6S60647YG			
		70	AXK5S70047YG	AXK6S70647YG			
		80	AXK5S80047YG	AXK6S80647YG			
		100	AXK5S00047YG	AXK6S00647YG			
		6.5 mm	20	AXK5S20247YG			AXK6S20647YG
			30	AXK5S30247YG			AXK6S30647YG
40	AXK5S40247YG		AXK6S40647YG				
50	AXK5S50247YG		AXK6S50647YG				
60	AXK5S60247YG		AXK6S60647YG				
70	AXK5S70247YG		AXK6S70647YG				
80	AXK5S80247YG		AXK6S80647YG				
100	AXK5S00247YG		AXK6S00647YG				
P5KS	7.0 mm		20	AXK5S20347YG	AXK6S20447YG	Socket: 1,000 pieces Header: 1,500 pieces	Socket: 2,000 pieces Header: 3,000 pieces
			30	AXK5S30347YG	AXK6S30447YG		
		40	AXK5S40347YG	AXK6S40447YG			
		50	AXK5S50347YG	AXK6S50447YG			
		60	AXK5S60347YG	AXK6S60447YG			
		70	AXK5S70347YG	AXK6S70447YG			
		80	AXK5S80347YG	AXK6S80447YG			
		100	AXK5S00347YG	AXK6S00447YG			

Narrow pitch connectors P5K, P5KS (0.5mm pitch)

Product name	Mated height	No. of pins	Part No.		Packing	
			Socket	Header	Inner carton (1 reel)	Outer carton
			TOUGH CONTACT	TOUGH CONTACT		
P5KS	8.0 mm	20	AXK5S20347YG	AXK6S20547YG	1,000 pieces	2,000 pieces
		30	AXK5S30347YG	AXK6S30547YG		
		40	AXK5S40347YG	AXK6S40547YG		
		50	AXK5S50347YG	AXK6S50547YG		
		60	AXK5S60347YG	AXK6S60547YG		
		70	AXK5S70347YG	AXK6S70547YG		
		80	AXK5S80347YG	AXK6S80547YG		
	100	AXK5S00347YG	AXK6S00547YG			
	9.0 mm	20	AXK5S20347YG	AXK6S20647YG		
		30	AXK5S30347YG	AXK6S30647YG		
		40	AXK5S40347YG	AXK6S40647YG		
		50	AXK5S50347YG	AXK6S50647YG		
		60	AXK5S60347YG	AXK6S60647YG		
		70	AXK5S70347YG	AXK6S70647YG		
80		AXK5S80347YG	AXK6S80647YG			
100	AXK5S00347YG	AXK6S00647YG				

- Notes: 1. Regarding ordering units: During production: Please make orders in 1 reel units.
 Samples for mounting confirmation: Available in units of 50 pieces. Please contact our sales office.
 Samples: Small lot orders are possible.
 2. The standard type comes without positioning bosses. Connectors with positioning bosses are available for on-demand production.

SPECIFICATIONS

1. Characteristics

Item	Specifications			Conditions																		
	3mm, 3.5mm type	4mm, 4.5mm, 5mm, 5.5mm, 6mm, 6.5mm type	7mm, 8mm, 9mm type																			
Electrical characteristics	Rated current	0.5A/terminal (Max. 10A) / 0.5A/terminal (Max. 16A)																				
	Rated voltage	60V AC/DC																				
	Breakdown voltage	150V AC for 1 min.		Detection current: 1mA																		
	Insulation resistance	Min. 1000MΩ		Using 500V DC megger																		
	Contact resistance	Max. 60mΩ	Max. 80mΩ	Based on the contact resistance measurement method specified by JIS C 5402.																		
Mechanical characteristics	Composite insertion force	Max. 0.785N × no. of pins (initial)																				
	Composite removal force	Min. 0.0588N × no. of pins																				
	Contact holding force	Min. 0.98N/pin contacts		Measuring the maximum force. As the contact & post is axially pull out.																		
Environmental characteristics	Ambient temperature	-55°C to +85°C		No freezing at low temperatures																		
	Soldering heat resistance	Max. peak temperature of 260°C (on the surface of the PC board around the connector terminals)		Infrared reflow soldering																		
		300°C within 5 sec., 350°C within 3 sec.		Soldering iron																		
	Thermal shock resistance (header and socket mated)	5 cycles, insulation resistance min. 100MΩ, contact resistance max. 60mΩ	5 cycles, insulation resistance min. 100MΩ, contact resistance max. 80mΩ	Conformed to MIL-STD-202F, method 107G <table border="1"> <thead> <tr> <th>Order</th> <th>Temperature (°C)</th> <th>Time (minutes)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>-55₋₃</td> <td>30</td> </tr> <tr> <td>2</td> <td>∩</td> <td>Max. 5</td> </tr> <tr> <td>3</td> <td>85⁺³</td> <td>30</td> </tr> <tr> <td>4</td> <td>∩</td> <td>Max. 5</td> </tr> <tr> <td></td> <td>-55₋₃</td> <td></td> </tr> </tbody> </table>	Order	Temperature (°C)	Time (minutes)	1	-55 ₋₃	30	2	∩	Max. 5	3	85 ⁺³	30	4	∩	Max. 5		-55 ₋₃	
	Order	Temperature (°C)	Time (minutes)																			
	1	-55 ₋₃	30																			
2	∩	Max. 5																				
3	85 ⁺³	30																				
4	∩	Max. 5																				
	-55 ₋₃																					
Humidity resistance (header and socket mated)	120 hours, insulation resistance min. 100MΩ, contact resistance max. 60mΩ	120 hours, insulation resistance min. 100MΩ, contact resistance max. 80mΩ	Bath temperature 40±2°C, humidity 90 to 95% R.H.																			
Saltwater spray resistance (header and socket mated)	24 hours, insulation resistance min. 100MΩ, contact resistance max. 60mΩ	24 hours, insulation resistance min. 100MΩ, contact resistance max. 80mΩ	Bath temperature 35±2°C, saltwater concentration 5±1%																			
H ₂ S resistance (header and socket mated)	48 hours, contact resistance max. 60mΩ	48 hours, contact resistance max. 80mΩ	Bath temperature 40±2°C, gas concentration 3±1 ppm, humidity 75 to 80% R.H.																			
Lifetime characteristics	Insertion and removal life	50 times		Repeated insertion and removal speed of max. 200 times/hours																		
Unit weight	P5K 3mm 30 pin contacts Socket: 0.17g Header: 0.09g P5KS 4mm 30 pin contacts Socket: 0.18g Header: 0.16g																					

2. Material and surface treatment

Part name	Mated height 3mm, 3.5mm, 4mm, 4.5mm, 5mm, 5.5mm, 6mm, 6.5mm, 7mm, 8mm, 9mm	
	Material	Surface treatment
Molded portion	Heat-resistant resin (UL94V-0)	—
Contact/post	Copper alloy	Contact portion: Ni plating on base, Au plating on surface Terminal portion: Ni plating on base, Au plating on surface (Except for thick of terminal) The section close to the soldering portion has a nickel barrier. (The nickel base is exposed.)

DIMENSIONS (Unit: mm)

The CAD data of the products with a **CAD Data** mark can be downloaded from: <http://industrial.panasonic.com/ac/e/>

P5K: Mated height 3mm, 3.5mm type

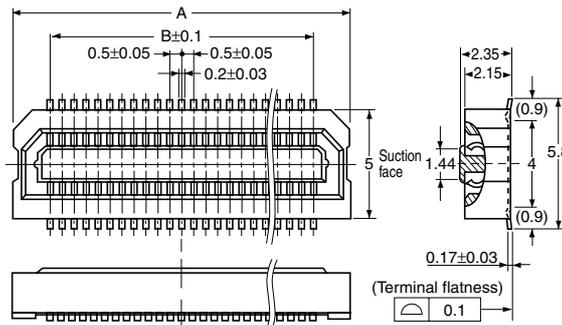
- Socket

CAD Data



Dimension table (mm)

No. of pins	A	B
20	8.20	4.50
22	8.70	5.00
30	10.70	7.00
34	11.70	8.00
40	13.20	9.50
50	15.70	12.00
60	18.20	14.50
70	20.70	17.00
80	23.20	19.50
100	28.20	24.50
120	33.20	29.50



General tolerance: ± 0.2

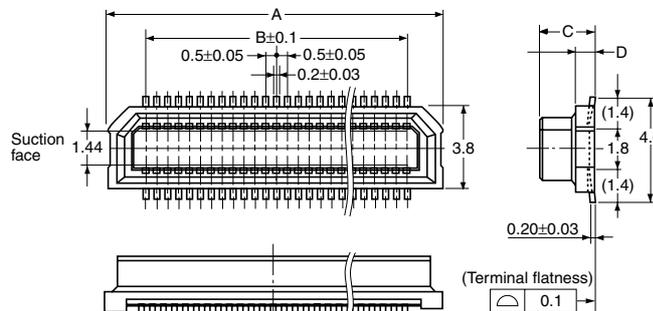
- Header

CAD Data



Dimension table (mm)

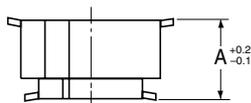
No. of pins	A	B
20	8.20	4.50
22	8.70	5.00
30	10.70	7.00
34	11.70	8.00
40	13.20	9.50
50	15.70	12.00
60	18.20	14.50
70	20.70	17.00
80	23.20	19.50
100	28.20	24.50
120	33.20	29.50



General tolerance: ± 0.2

Mated height	C	D
3.0 mm	2.40	0.85
3.5 mm	2.90	1.35

- Socket and header are mated



Mated height	A
3.0 mm	3.00
3.5 mm	3.50

Note: P5KS series (mated heights 4.0mm, 4.5mm, 5.0mm, 5.5mm, 6.0mm, 6.5mm, 7.0mm, 8.0mm, and 9.0mm) cannot be mated to this type.

Narrow pitch connectors P5K, P5KS (0.5mm pitch)

P5KS: Mated height 4.0mm, 4.5mm, 5.0mm, 5.5mm, 6.0mm, 6.5mm, 7.0mm, 8.0mm, 9.0mm type

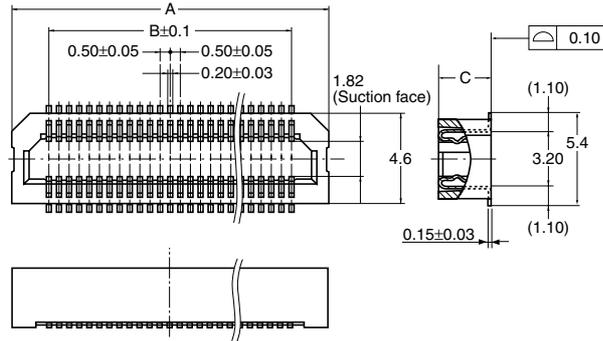
- Socket

CAD Data



Dimension table (mm)

No. of pins	A	B
20	8.20	4.50
24	9.20	5.50
30	10.70	7.00
34	11.70	8.00
36	12.20	8.50
40	13.20	9.50
50	15.70	12.00
60	18.20	14.50
70	20.70	17.00
80	23.20	19.50
100	28.20	24.50



General tolerance: ± 0.2

Mated height	C
4.0 mm, 5.0 mm, 6.0 mm	3.05
4.5 mm, 5.5 mm, 6.5 mm	3.55
7.0 mm, 8.0 mm, 9.0 mm	6.05

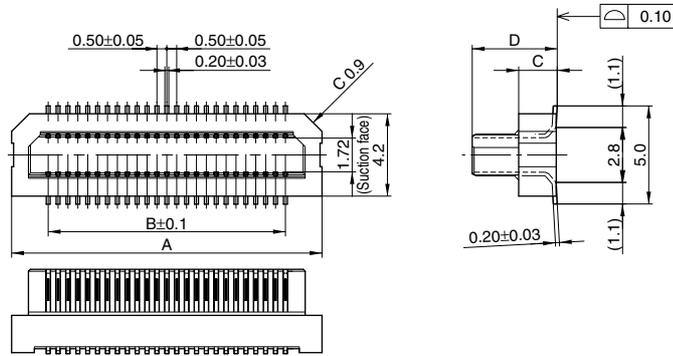
- Header

CAD Data



Dimension table (mm)

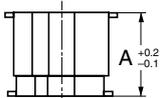
No. of pins	A	B
20	8.20	4.50
24	9.20	5.50
30	10.70	7.00
34	11.70	8.00
36	12.20	8.50
40	13.20	9.50
50	15.70	12.00
60	18.20	14.50
70	20.70	17.00
80	23.20	19.50
100	28.20	24.50



General tolerance: ± 0.2

Mated height	C	D
4.0 mm, 4.5 mm, 7.0 mm	0.95	3.30
5.0 mm, 5.5 mm, 8.0 mm	1.95	4.30
6.0 mm, 6.5 mm, 9.0 mm	2.95	5.30

- Socket and header are mated



Mated height	A
4.0 mm	4.00
4.5 mm	4.50
5.0 mm	5.00
5.5 mm	5.50
6.0 mm	6.00
6.5 mm	6.50
7.0 mm	7.00
8.0 mm	8.00
9.0 mm	9.00

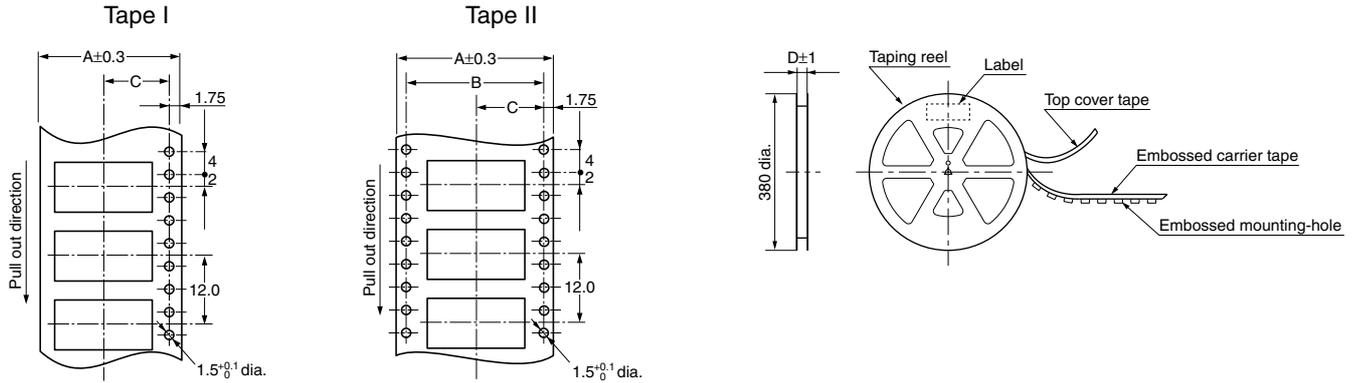
Note: P5K series (mated heights 3.0mm, 3.5mm) cannot be mated to this type.

EMBOSSED TAPE DIMENSIONS (unit: mm, Common for respective contact type, socket and header)

• Tape dimensions (Conforming to JIS C 0806:1990.

• Plastic reel dimensions (Conforming to EIAJ ET-7200B)

However, some tapes have mounting hole pitches that do not comply with the standard.)

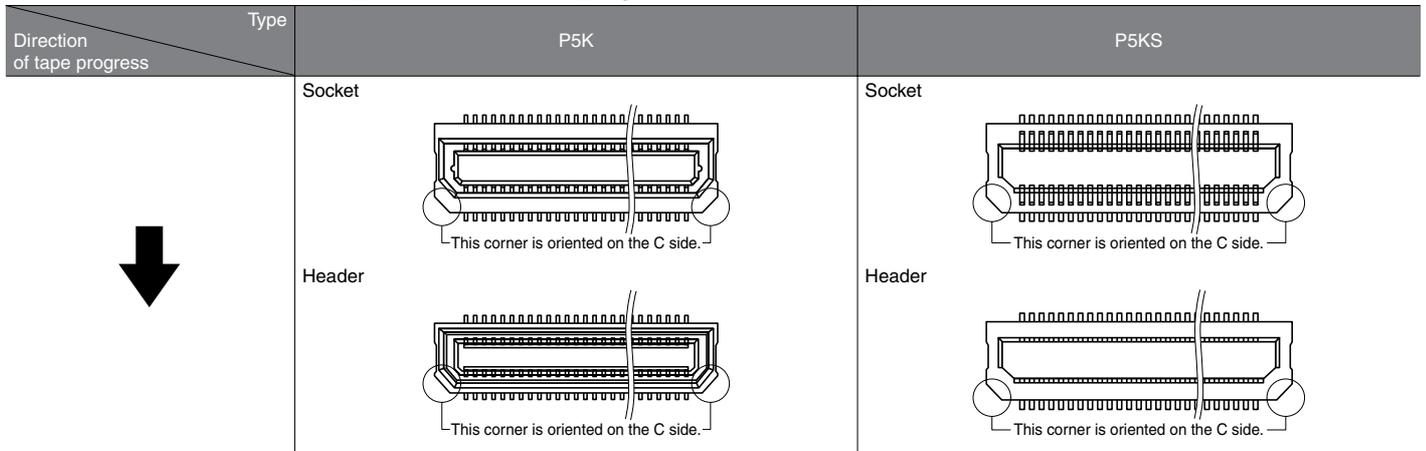


Dimension table (mm)

Suffix: G (1 reel, 1,500 pieces or 1,000 pieces embossed tape and plastic reel package)

Type	Mated height	No. of pins	Type of taping	A	B	C	D	Quantity per reel
P5K	Socket and header are common 3.0mm, 3.5mm	20 to 50	Tape I	24.0	—	11.5	25.4	1,500 pcs.
		60 to 70	Tape II	32.0	28.4	14.2	33.4	
		80 to 100	Tape II	44.0	40.4	20.2	45.4	
		120	Tape II	56.0	52.4	26.2	57.4	
P5KS	Socket: 4.0mm, 4.5mm, 5.0mm, 5.5mm, 6.0mm, 6.5mm Header: 4.0mm, 4.5mm, 7.0mm	20 to 50	Tape I	24.0	—	11.5	25.4	1,500 pcs.
		60 to 70	Tape II	32.0	28.4	14.2	33.4	
		80 to 100	Tape II	44.0	40.4	20.2	45.4	
	Socket: 7.0mm, 8.0mm, 9.0mm Header: 5.0mm, 5.5mm, 6.0mm, 6.5mm, 8.0mm, 9.0mm	20 to 50	Tape I	24.0	—	11.5	25.4	1,000 pcs.
		60 to 70	Tape II	32.0	28.4	14.2	33.4	
		80 to 100	Tape II	44.0	40.4	20.2	45.4	

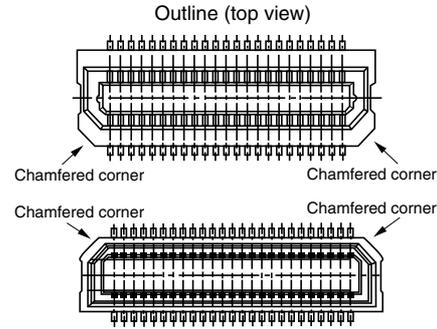
Connector orientation with respect to direction of progress of embossed tape



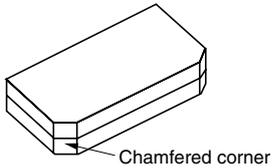
NOTES

1. Prevention of reverse mating

The socket and header are protected from reverse mating by a molded resin key. Excessive mating force may damage the key, so be sure to match chamfered corners when mating.



Mating state



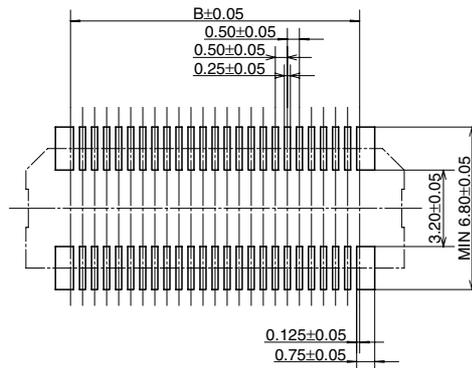
2. Recommended PC board and metal mask patterns

Connectors are mounted with high pitch density, intervals of 0.35 mm, 0.4 mm or 0.5 mm.

In order to reduce solder and flux rise, solder bridges and other issues make sure the proper levels of solder is used. The figures to the right are recommended metal mask patterns. Please use them as a reference.

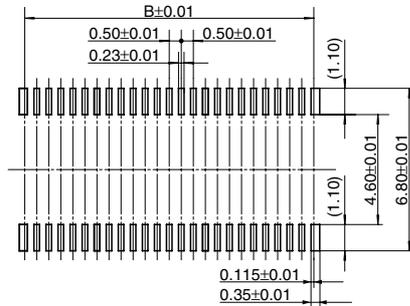
• P5K Socket

Recommended PC board pattern (TOP VIEW)



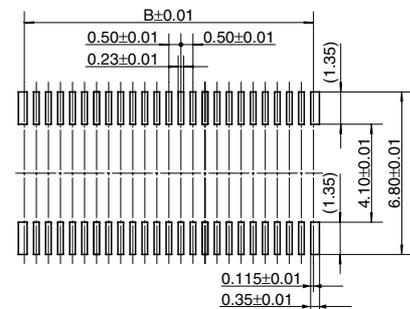
Recommended metal mask pattern

Metal mask thickness: When 150 μm
(Opening area ratio: 56%)



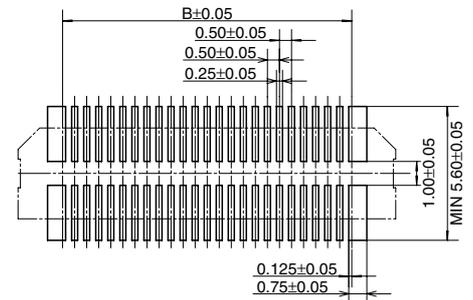
Recommended metal mask pattern

Metal mask thickness: When 120 μm
(Opening area ratio: 69%)



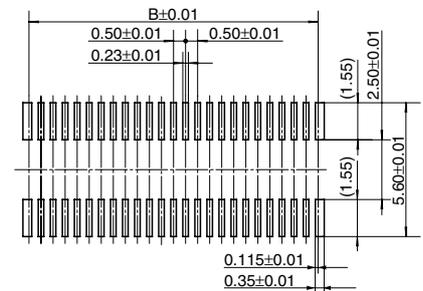
• P5K Header

Recommended PC board pattern (TOP VIEW)



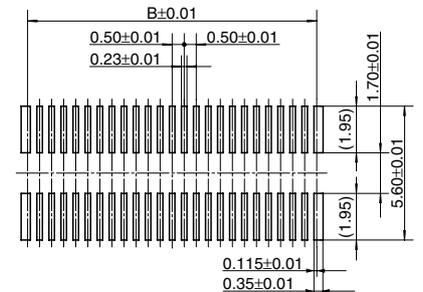
Recommended metal mask pattern

Metal mask thickness: When 150 μm
(Opening area ratio: 62%)



Recommended metal mask pattern

Metal mask thickness: When 120 μm
(Opening area ratio: 78%)

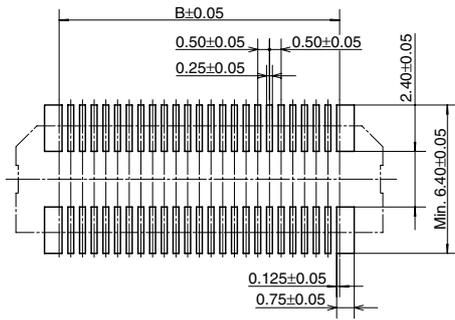


* See the dimension table on page 5 for more information on the B dimension of the socket and header.

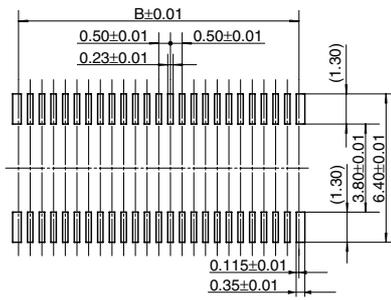
P5KS: Mated height 4.0mm, 4.5mm, 5.0mm, 5.5mm, 6.0mm, 6.5mm, 7.0mm, 8.0mm, 9.0mm type

• Socket

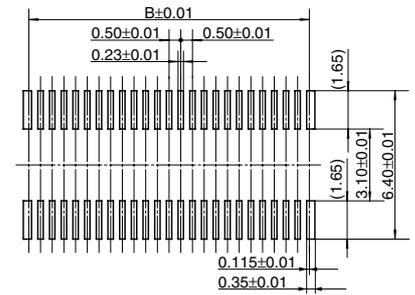
Recommended PC board pattern
(TOP VIEW)



Recommended metal mask pattern
Metal mask thickness: When 150 μm
(Opening area ratio: 60%)



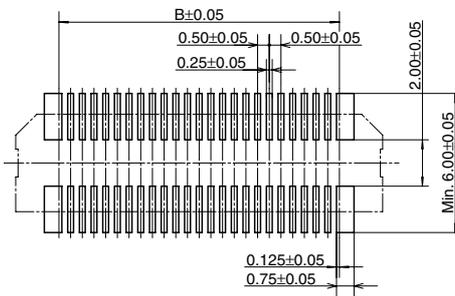
Recommended metal mask pattern
Metal mask thickness: When 120 μm
(Opening area ratio: 76%)



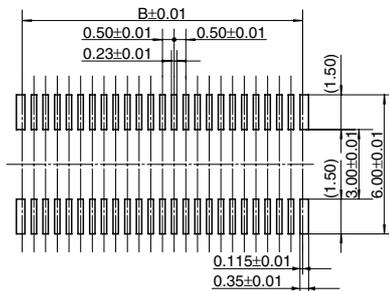
* See the dimension table on page 6 for more information on the B dimension.

• Header

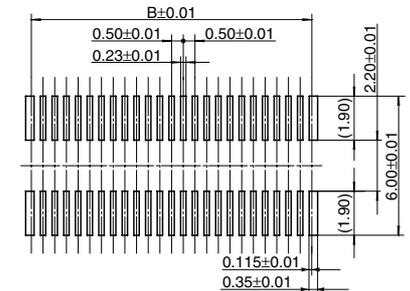
Recommended PC board pattern
(TOP VIEW)



Recommended metal mask pattern
Metal mask thickness: When 150 μm
(Opening area ratio: 69%)



Recommended metal mask pattern
Metal mask thickness: When 120 μm
(Opening area ratio: 87%)



* See the dimension table on page 6 for more information on the B dimension.

Please refer to the latest product specifications when designing your product.

Notes on Using Narrow pitch Connectors

Regarding the design of devices and PC board patterns

1) When connecting several connectors together by stacking, make sure to maintain proper accuracy in the design of structure and mounting equipment so that the connectors are not subjected to twisting and torsional forces.

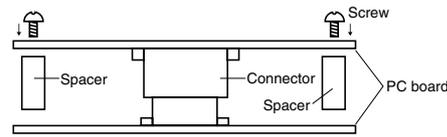
2) With mounting equipment, there may be up to a ± 0.2 to 0.3-mm error in positioning. Be sure to design PC boards and patterns while taking into consideration the performance and abilities of the required equipment.

3) Some connectors have tabs embossed on the body to aid in positioning. When using these connectors, make sure that the PC board is designed with positioning holes to match these tabs.

4) To ensure the required mechanical strength when soldering the connector terminals, make sure the PC board meets recommended PC board pattern design dimensions given.

5) For all connectors of the narrow pitch series, to prevent the PC board from coming off during vibrations or impacts, and to prevent loads from falling directly on the soldered portions, be sure to design some means to fix the PC board in place.

Example) Secure in place with screws



When connecting PC boards, take appropriate measures to prevent the connector from coming off.

6) Notes when using a FPC.

(1) When the connector is soldered to an FPC board, during its insertion and removal procedures, forces may be applied to the terminals and cause the soldering to come off. It is recommended to use a reinforcement board on the

backside of the FPC board to which the connector is being connected. Please make the reinforcement board dimensions bigger than the outer limits of the recommended PC board pattern (should be approximately 1 mm greater than the outer limit).

Material should be glass epoxy or polyimide, and the thickness should be between 0.2 and 0.3 mm.

(2) Collisions, impacts, or turning of FPC boards, may apply forces on the connector and cause it to come loose.

Therefore, make to design retaining plates or screws that will fix the connector in place.

7) The narrow pitch connector series is designed to be compact and thin.

Although ease of handling has been taken into account, take care when mating the connectors, as displacement or angled mating could damage or deform the connector.

Regarding the selection of the connector placement machine and the mounting procedures

1) Select the placement machine taking into consideration the connector height, required positioning accuracy, and packaging conditions.

2) Be aware that if the catching force of the placement machine is too great, it may deform the shape of the connector body or connector terminals.

3) Be aware that during mounting, external forces may be applied to the connector contact surfaces and terminals and cause deformations.

4) Depending on the size of the connector being used, self alignment may not be possible. In such cases, be sure to carefully position the terminal with the PC board pattern.

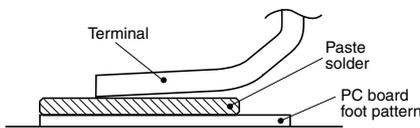
5) The positioning bosses give an approximate alignment for positioning on the PC board. For accurate positioning of the connector when mounting it to the PC board, we recommend using an automatic positioning machine.

6) Excessive mouter chucking force may deform the molded or metal part of the connector. Consult us in advance if chucking is to be applied.

Regarding soldering

1. Reflow soldering

- 1) Measure the recommended profile temperature for reflow soldering by placing a sensor on the PC board near the connector surface or terminals. (The setting for the sensor will differ depending on the sensor used, so be sure to carefully read the instructions that comes with it.)
- 2) As for cream solder printing, screen printing is recommended.
- 3) To determine the relationship between the screen opening area and the PC-board foot pattern area, refer to the diagrams in the recommended patterns for PC boards and metal masks. Make sure to use the terminal tip as a reference position when setting. Avoid an excessive amount of solder from being applied, otherwise, interference by the solder will cause an imperfect contact.

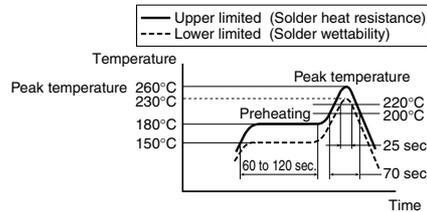


- 4) Consult us when using a screen-printing thickness other than that recommended.
- 5) When mounting on both sides of the PC board and the connector is mounting on the underside, use adhesives or other means to ensure the connector is properly fixed to the PC board. (Double reflow soldering on the same side is possible.)
- 6) N₂ reflow, conducting reflow soldering in a nitrogen atmosphere, increases the solder flow too greatly, enabling wicking to occur. Make sure that the solder feed rate and temperature profile are appropriate.

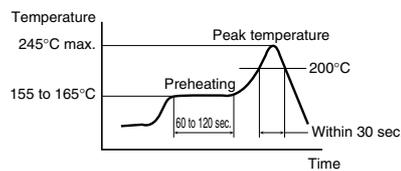
Soldering conditions

Please use the reflow temperature profile conditions recommended below for reflow soldering. Please contact us before using a temperature profile other than that described below (e.g. lead-free solder).

- Narrow pitch connectors (except P8 type)



- Narrow pitch connector (P8)



For products other than the ones above, please refer to the latest product specifications.

- 7) The temperatures are measured at the surface of the PC board near the connector terminals. (The setting for the sensor will differ depending on the sensor used, so be sure to carefully read the instructions that comes with it.)
- 8) The temperature profiles given in this catalog are values measured when using the connector on a resin-based PC board. When performed reflow soldering on a metal board (iron, aluminum, etc.) or a metal table to mount on a FPC, make sure there is no deformation or discoloration of the connector beforehand and then begin mounting.
- 9) Consult us when using a screen-printing thickness other than that recommended.
- 10) Some solder and flux types may cause serious solder or flux creeping. Solder and flux characteristics should be taken into consideration when setting the reflow soldering conditions.

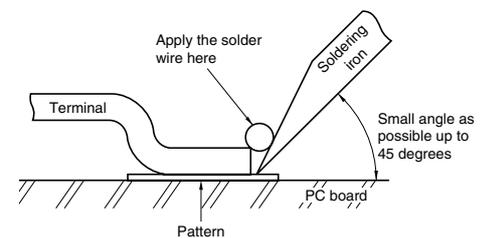
2. Hand soldering

- 1) Set the soldering iron so that the tip temperature is less than that given in the table below.

Table A

Product name	Soldering iron temperature
SMD type connectors	300°C within 5 sec. 350°C within 3 sec.

- 2) Do not allow flux to spread onto the connector leads or PC board. This may lead to flux rising up to the connector inside.
- 3) Touch the soldering iron to the foot pattern. After the foot pattern and connector terminal are heated, apply the solder wire so it melts at the end of the connector terminals.



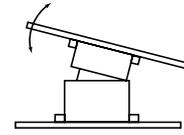
- 4) Be aware that soldering while applying a load on the connector terminals may cause improper operation of the connector.
 - 5) Thoroughly clean the soldering iron.
 - 6) Flux from the solder wire may get on the contact surfaces during soldering operations. After soldering, carefully check the contact surfaces and clean off any solder before use.
 - 7) For soldering of prototype devices during product development, you can perform soldering at the necessary locations by heating with a hot-air gun by applying cream solder to the foot pattern beforehand. However, at this time, make sure that the air pressure does not move connectors by carefully holding them down with tweezers or other similar tool. Also, be careful not to go too close to the connectors and melt any of the molded components.
 - 8) If an excessive amount of solder is applied during manual soldering, the solder may creep up near the contact points, or solder interference may cause imperfect contact.
- ### 3. Solder reworking
- 1) Finish reworking in one operation.
 - 2) For reworking of the solder bridge, use a soldering iron with a flat tip. To prevent flux from climbing up to the contact surfaces, do not add more flux.
 - 3) Keep the soldering iron tip temperature below the temperature given in Table A.

Handling Single Components

- 1) Make sure not to drop or allow parts to fall from work bench
- 2) Excessive force applied to the terminals could cause warping, come out, or weaken the adhesive strength of the solder. Handle with care.
- 3) Repeated bending of the terminals may cause terminals to break.

- 4) Do not insert or remove the connector when it is not soldered. Forcibly applied external pressure on the terminals can weaken the adherence of the terminals to the molded part or cause the terminals to lose their evenness.
- 5) Excessive prying-force applied to one end may cause product breakage and separation of the solder joints at the terminal.

Excessive force applied for insertion in a pivot action as shown may also cause product breakage. Align the header and socket positions before connecting them.



Cleaning flux from PC board

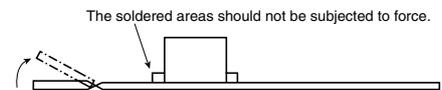
- 1) To increase the cleanliness of the cleaning fluid and cleaning operations, prepare equipment for cleaning process beginning with boil cleaning, ultrasonic cleaning, and then vapor cleaning.
- 2) Carefully oversee the cleanliness of the cleaning fluids to make sure that the contact surfaces do not become dirty from the cleaning fluid itself.

- 3) Since some powerful cleaning solutions may dissolve molded components of the connector and wipe off or discolor printed letters, we recommend aqua pura electronic parts cleaners. Please consult us if you wish to use other types of cleaning fluids.
- 4) Please note that the surfaces of molded parts may whiten when cleaned with alcohol.

Handling the PC board

• Handling the PC board after mounting the connector

When cutting or bending the PC board after mounting the connector, be careful that the soldered sections are subjected to excessive force.



Storage of connectors

- 1) To prevent problems from voids or air pockets due to heat of reflow soldering, avoid storing the connectors in areas of high humidity. When storing the connectors for more than six months, be sure to consider storage area where the humidity is properly controlled.
- 2) Depending on the connector type, the color of the connector may vary from connector to connector depending on when it is produced.

- Some connectors may change color slightly if subjected to ultraviolet rays during storage. This is normal and will not affect the operation of the connector.
- 3) When storing the connectors with the PC boards assembled and components already set, be careful not to stack them up so the connectors are subjected to excessive forces.

- 4) Avoid storing the connectors in locations with excessive dust. The dust may accumulate and cause improper connections at the contact surfaces.

Other Notes

- 1) These products are made for the design of compact and lightweight devices and therefore the thickness of the molded components has been made very thin. Therefore, be careful during insertion and removal operations for excessive forces applied may damage the products.
- 2) Dropping of the products or rough mishandling may bend or damage the terminals and possibly hinder proper reflow soldering.

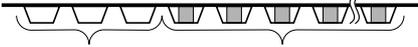
- 3) Before soldering, try not to insert or remove the connector more than absolutely necessary.
- 4) When coating the PC board after soldering the connector to prevent the deterioration of insulation, perform the coating in such a way so that the coating does not get on the connector.
- 5) There may be variations in the colors of products from different production lots. This is normal.

- 6) The connectors are not meant to be used for switching.
- 7) Be sure not to allow external pressure to act on connectors when assembling PCBs or moving in block assemblies.

Regarding sample orders to confirm proper mounting

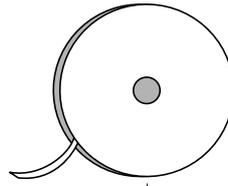
When ordering samples to confirm proper mounting with the placement machine, connectors are delivered in 50-piece units in the condition given right. Consult a sale representative for ordering sample units.

Condition when delivered from manufacturing



Embossed tape amount required for the mounting

Required number of products for sample production (Unit 50 pcs.)



Reel

(Delivery can also be made on a reel by customer request.)

Please refer to the latest product specifications when designing your product.